

Ryton® R-4-240NA polyphenylene sulfide

Ryton® R-4-240NA and R-4-240BL 40% glass fiber reinforced polyphenylene sulfide compounds provide enhanced mechanical strength and

toughness compared to other polyphenylene sulfide compounds.

Material Status	Commercial: Active		
	Asia Pacific	• Latin America	
Availability	• Europe	North America	
Filler / Reinforcement	Glass Fiber, 40% Filler by Weight		
Features	Good Strength	Good Toughness	
Uses	Automotive Applications	S	
RoHS Compliance	 RoHS Compliant 		
Appearance	 Natural Color 		
Forms	 Pellets 		
Processing Method	 Injection Molding 		
Physical		Typical Value Unit	Test method
Density / Specific Gravity		1.66	ASTM D792
Molding Shrinkage			
Flow : 3.20 mm		0.20 %	
Across Flow : 3.20 mm		0.50 %	
Water Absorption (24 hr, 23°C)		0.020 %	ASTM D570
Mechanical		Typical Value Unit	Test method
Tensile Strength			
		172 MPa	ASTM D638
		185 MPa	ISO 527-2
Tensile Elongation			
Break		1.9 %	ASTM D638
Break		2.0 %	ISO 527-2
Flexural Modulus			
		13800 MPa	ASTM D790
		14000 MPa	ISO 178
Flexural Strength			
		262 MPa	ASTM D790
		275 MPa	ISO 178
Compressive Strength		265 MPa	ASTM D695

Poisson's Ratio

0.39

ISO 527

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Impact	Typical Value Unit	Test method
Notched Izod Impact		
3.18 mm	91 J/m	ASTM D256
	10 kJ/m²	ISO 180/A
Unnotched Izod Impact		
3.18 mm	800 J/m	ASTM D4812
	45 kJ/m²	ISO 180
Hardness	Typical Value Unit	Test method
Rockwell Hardness		ASTM D785
M-Scale	99	
R-Scale	120	
Thermal	Typical Value Unit	Test method
Deflection Temperature Under Load		ASTM D648
1.8 MPa, Unannealed	265 °C	
CLTE		ASTM E831
Flow: -50 to 50°C	2.0E-5 cm/cm/°C	
Flow: 100 to 200°C	1.5E-5 cm/cm/°C	
Transverse: -50 to 50°C	4.0E-5 cm/cm/°C	
Transverse: 100 to 200°C	9.0E-5 cm/cm/°C	
Thermal Conductivity	0.31 W/m/K	
UL Temperature Rating	200 to 220 °C	UL 746B
Electrical	Typical Value Unit	Test method
Surface Resistivity	1.0E+16 ohms	ASTM D257
Volume Resistivity	1.0E+16 ohms·cm	ASTM D257
Dielectric Strength	22 kV/mm	ASTM D149
Dielectric Constant		ASTM D150
25°C, 1 kHz	3.90	
25°C, 1 MHz	4.00	
Dissipation Factor		ASTM D150
25°C, 1 kHz	2.0E-3	
25°C, 1 MHz	2.0E-3	
Arc Resistance	130 sec	ASTM D495
Comparative Tracking Index (CTI)	175 V	IEC 60112
Comparative Tracking Index (CTI)	PLC 4	UL 746A
Insulation Resistance ¹ (90°C)	1.0E+12 ohms	
Flammability	Typical Value Unit	Test method
Flame Rating (1.6 mm)	V-05VA	UL 94
Oxygen Index	54 %	ASTM D2863
10:	2.70	

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Notes

Typical properties: these are not to be construed as specifications.

¹ 95%RH, 48 hr

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